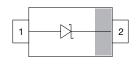


Small Signal Schottky Diode





LINKS TO ADDITIONAL RESOURCES











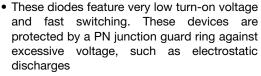
MECHANICAL DATA

Case: SOD-123

Weight: approx. 10.6 mg
Packaging codes/options:

18/10K per 13" reel (8 mm tape), 10K/box 08/3K per 7" reel (8 mm tape), 15K/box

FEATURES





- For general purpose applications
- AEC-Q101 qualified available
- Molding compound meets UL 94 V-0 flammability rating



- Moisture Sensitivity Level (MSL) 1
- Base P/N-E3 RoHS-compliant, commercial grade
- Base P/N-HE3 RoHS-compliant, AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

PARTS TABLE							
PART	ORDERING CODE	AEC-Q101 QUALIFIED	TYPE MARKING	CIRCUIT CONFIGURATION	TAPED UNITS PER REEL	MINIMUM ORDER QUANTITY	
BAT42W	BAT42W-E3-08	no			3 000	15 000	
	BAT42W-HE3_A-08	yes	LC	Single	(8 mm tape on 7" reel)		
	BAT42W-E3-18	no		Sirigle	10 000	10 000	
	BAT42W-HE3_A-18	yes			(8 mm tape on 13" reel)	10 000	
BAT43W	BAT43W-E3-08	no			3 000	15 000	
	BAT43W-HE3_A-08	yes	LD	Single	(8 mm tape on 7" reel)	10 000	
	BAT43W-E3-18	no		Single	10 000		
	BAT43W-HE3_A-18	yes			(8 mm tape on 13" reel)	10 000	

PACKAGE						
PACKAGE NAME WEIGHT		MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS		
SOD-123	10.6 mg	UL 94 V-0	MSL 1 (according J-STD-020)	Peak temperature max. 260 °C		

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	ARAMETER TEST CONDITION		VALUE	UNIT		
Repetitive peak reverse voltage		V_{RRM}	30	V		
Forward continuous current (1)		I _F	300	mA		
Repetitive peak forward current (1)		I _{FRM}	500	mA		
Surge forward current (1)	Duty cycle t _p / T < 0.5	I _{FSM}	4	Α		
Power dissipation	On FR-4 board with recommended soldering footprint	В	230	mW		
Fower dissipation	Infinite heatsink	P _{tot}	350	mW		

Note

(1) Infinite heatsink





THERMAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
Thermal resistance junction to ambient air	according to JEDEC® 51-3 on FR-4 board with recommended soldering footprint	R _{thJA}	420	K/W			
Thermal resistance junction lead	Infinite heatsink	R _{thJL}	280	K/W			
Maximum junction temperature		T _j	125	°C			
Storage temperature range		T _{stg}	-65 to +150	°C			
Operating temperature range		T _{op}	-55 to +125	°C			

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Reverse breakdown voltage	$I_R = 100 \mu A \text{ (pulsed)}$		V _(BR)	30			V
Leakage current (1)	V _R = 25 V		I _R			0.5	μA
Leakage current (1)	V _R = 25 V, T _j = 100 °C		I _R			100	μA
	I _F = 200 mA		V _F			1000	mV
	I _F = 10 mA	BAT42W	V _F			400	mV
Forward voltage (1)	I _F = 50 mA	BAT42W	V _F			650	mV
	I _F = 2 mA	BAT43W	V _F	260		330	mV
	I _F = 15 mA	BAT43W	V _F			450	mV
Diode capacitance	V _R = 1 V, f = 1 MHz		C _D		7		pF
Reverse recovery time	$I_F = 10 \text{ mA}, I_R = 10 \text{ mA},$ $I_R = 1 \text{ mA}, R_L = 100 \Omega$		t _{rr}			5	ns

Note

 $^{^{(1)}}$ Pulse test; $t_p \leq 300~\mu s,$ duty cycle $t_p/T < 0.02$

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

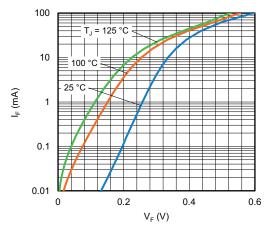


Fig. 1 - Typical Forward Current vs. Forward Voltage

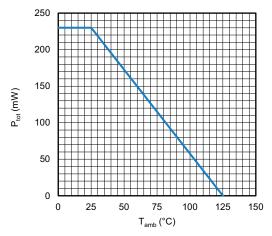


Fig. 2 - Admissible Power Dissipation vs. Ambient Temperature

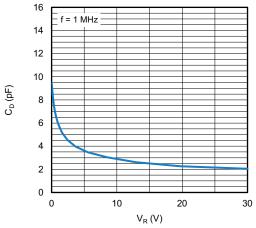


Fig. 3 - Typical Reverse Characteristics

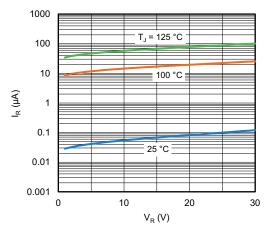
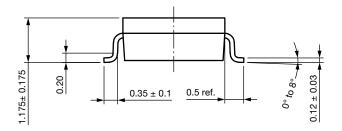
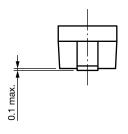


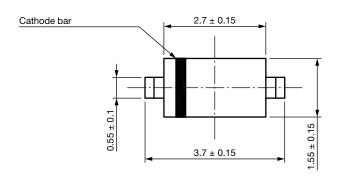
Fig. 4 - Typical Capacitance vs. Reverse Voltage

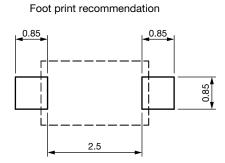


PACKAGE DIMENSIONS in millimeters (inches): SOD-123









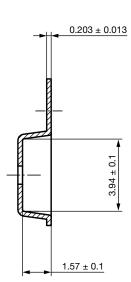
Rev. 01 - Date: 18. Jan. 2022 Document no.: S8-V-3910.01-003 (4)

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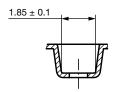


CARRIER TAPE SOD-123

A - A section 1.75 ± 0.1 2 ± 0.05 4 ± 0.1 \emptyset 1.55 ± 0.05 <u>Ø1</u> +0.25 0.00 3.5 ± 0.05 8 -0.1 В В 4 ± 0.1



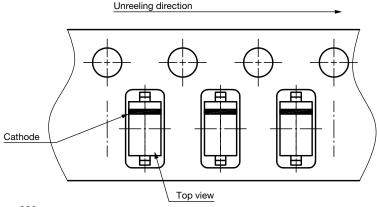
B - B section



Rev. 02 - Date: 21. Jan. 2014 Document no.: S8-V-3717.10-002 (4)

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ORIENTATION IN CARRIER TAPE SOD-123



Rev. 02 - Date: 07. Nov. 2022 Document no.: S8-V-3717.10-003 (4)

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